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- **Extended Temperature Performance of** -40°C to 125°C
- Optimized for Off-line and DC to DC Converters
- Low Start Up Current (<0.5 mA)
- **Trimmed Oscillator Discharge Current**
- **Automatic Feed Forward Compensation**
- **Pulse-by-Pulse Current Limiting**
- Enhanced Load Response Characteristics
- **Under-Voltage Lockout With Hysteresis**
- **Double Pulse Suppression**
- **High Current Totem Pole Output**
- Internally Trimmed Bandgap Reference
- 500 kHz Operation
- Low RO Error Amp

D 8-PIN PACKAGE (TOP VIEW) COMP VREF V_{FB} 7 Vcc 6 OUTPUT SENSE **GND** R_T/C_T D 14-PIN PACKAGE (TOP VIEW) COMP 14 🛮 V_{REF} NC 1 2 13 NC V_{FB} [] 3 12 VCC NC I 4 11 VC 10 OUTPUT SENSE 4 5 9 GND NC 6 8 PWR GND R_T/C_T 7

description

The UC2842A/3A/4A/5A family of control ICs is a pin for pin compatible improved version of the UC2842/3/4/5 family. Providing the necessary features to control current mode switched mode power supplies, this family has the following improved features. Start up current is guaranteed to be less than 0.5 mA. Oscillator discharge is trimmed to 8.3 mA. During under voltage lockout, the output stage can sink at least 10 mA at less than 1.2 V for V_{CC} over 5 V.

The difference between members of this family are shown in the table below.

veen members o	of this family a	re shown in t	he table below.
PART NUMBER	UVLO ON	UVLO OFF	MAXIMUM DUTY CYCLE
UC2842A	16 V	10 V	<100%
UC2843A	8.5 V	7.9 V	<100%
UC2844A	16 V	10 V	<50%
UC2845A	8.5 V	7.9 V	<50%

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

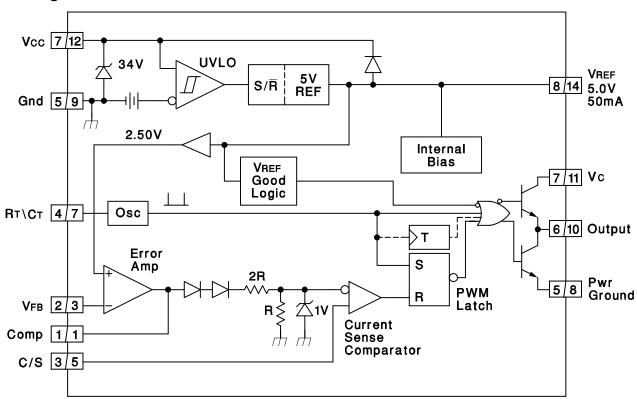


ORDERING INFORMATION[†]

т _А	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC-8 – D8	Tape and reel	UC2842AQD8R	2842AQ
	SOIC-8 – D8	Tube	UC2842AQD8	2842AQ
	SOIC-14 – D	Tape and reel	UC2842AQDR	2842AQ
	SOIC-14 – D	Tube	UC2842AQD	2842AQ
	SOIC-8 – D8	Tape and reel	UC2843AQD8R	2843AQ
	SOIC-8 – D8	Tube	UC2843AQD8	2843AQ
	SOIC-14 – D	Tape and reel	UC2843AQDR	2843AQ
–40°C to 125°C	SOIC-14 – D	Tube	UC2843AQD	2843AQ
-40 C to 125 C	SOIC-8 – D8	Tape and reel	UC2844AQD8R	2844AQ
	SOIC-8 – D8	Tube	UC2844AQD8	2844AQ
	SOIC-14 – D	Tape and reel	UC2844AQDR	2844AQ
	SOIC-14 – D	Tube	UC2844AQD	2844AQ
	SOIC-8 – D8	Tape and reel	UC2845AQD8R	2845AQ
	SOIC-8 - D8	Tube	UC2845AQD8	2845AQ
	SOIC-14 – D	Tape and reel	UC2845AQDR	2845AQ
	SOIC-14 – D	Tube	UC2845AQD	2845AQ

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

block diagram



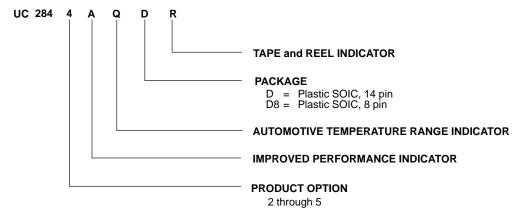
NOTES: 1. A = DIL-8 Pin Number. B = SO-14 Pin Number.

2. Toggle flip flop used only in 2844A and 2845A.



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Ordering Information



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NOTE 1: Long term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

electrical characteristics, $T_A = -40^{\circ}C$ to 125°C, $V_{CC} = 15$ V (see Note 1), $R_T = 10$ k Ω , $C_T = 3.3$ nF, and $T_A = T_J$ (unless otherwise stated)

PARAMETER		TEST CONDITIONS					UNITS
Reference Section	•						
Output voltage	$T_J = 25^{\circ}C$,	I _O = 1 mA		4.95	5.0	5.05	V
Line regulation voltage	V _{IN} = 12 V to 25 V	,			6	20	mV
Load regulation voltage	I _O = 1 mA to 20 m	A			6	25	mV
Temperature stability	See Notes 2 and 3	}			0.2	0.4	mV/°C
Total output variation voltage	Line, Load, Temp.			4.9		5.1	V
Output noise voltage	f = 10 Hz to 10 kHz See Note 2	Z,	T _J = 25°C		50		μV
Long term stability	1000 hours,	See Note 2	T _A = 125°C		5	25	mV
Output short-circuit current				-30	-100	-180	mA
Oscillator Section							
Initial accuracy	See Note 4		T _J = 25°C	47	52	57	kHz
Voltage stability	V _{CC} = 12 V to 25	V			0.2	1	%
Temperature stability	$T_A = MIN \text{ to MAX},$	See Note 2			5		%
Amplitude peak-to-peak	V pin 7,	See Note 2			1.7		V
Discharge current	V pin 7 = 2 V,	Con Note 5	T _J = 25°C	7.8	8.3	8.8	A
Discharge current		See Note 5	T _J = Full range	7.5		8.8	mA

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.

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electrical characteristics, $T_A = -40^{\circ}C$ to 125°C, $V_{CC} = 15 \text{ V}$ (see Note 1), $R_T = 10 \text{ k}\Omega$, $C_T = 3.3 \text{ nF}$, and $T_A = T_J$ (unless otherwise stated)

PARAMETER		MIN	TYP	MAX	UNITS		
Error Amplifier Section							
Input voltage	COMP = 2.5 V			2.45	2.5	2.55	V
Input bias current					-0.3	-1	μА
Open loop voltage gain (A _{VOL)}	V _O = 2 V to 4 V			65	90		dB
Unity gain bandwidth	See Note 2		T _J = 25°C	0.7	1		MHz
PSRR	V _{CC} = 12 V to 2	25 V		60	70		dB
Output sink current	FB = 2.7 V,	COMP = 1.1 V		2	6		mA
Output source current	FB = 2.3 V,	COMP = 5 V		-0.5	-0.8		mA
V _{OUT} high	FB = 2.3 V,	$R_L = 15 \text{ k}\Omega$ to G	SND	5	6		V
V _{OUT} low	FB = 2.7 V,	$R_L = 15 \text{ k}\Omega \text{ to V}$	'REF		0.7	1.1	V
Current Sense Section							
Gain	See Notes 6 and	d 7		2.85	3	3.15	V/V
Maximum input signal	COMP = 5 V,	See Note 6		0.9	1	1.1	V
PSRR	V _{CC} = 12 V to 2	25 V, See Note 6			70		dB
Input bias current					-2	-10	μА
Delay to output	I _{SENSE} = 0 V to	o 2 V, See N	Note 2		150	300	ns
Output Section (OUT)							
Law law Law tantant and tank	I _{OUT} = 20 mA	I _{OUT} = 20 mA					V
Low-level output voltage	I _{OUT} = 200 mA	I _{OUT} = 200 mA					V
IPak basal autost salta sa	I _{OUT} = -20 mA	$I_{OUT} = -20 \text{ mA}$.,
High-level output voltage	I _{OUT} = -200 m	I _{OUT} = -200 mA					V
Rise time	C _L = 1 nF,	See Note 2	T _J = 25°C		50	150	ns
Fall time	C _L = 1 nF,	See Note 2	T _J = 25°C		50	150	ns
UVLO saturation	V _{CC} = 5 V,	I _{OUT} = 10 mA	•		0.7	1.2	V
Undervoltage Lockout Section							
0			UC2842A, UC2844A	15	16	17	.,
Start threshold			UC2843A, UC2845A	7.8	8.4	9	V
			UC2842A, UC2844A	9	10	11	.,
Minimum operation voltage after turn on			UC2843A, UC2845A	7	7.6	8.2	V

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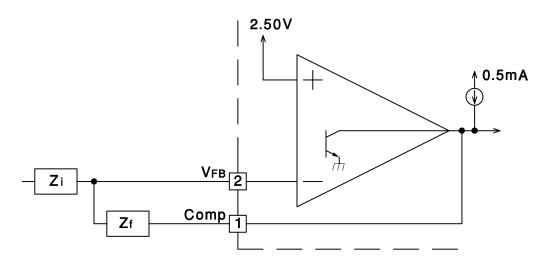
electrical characteristics, $T_A = -40$ °C to 125 °C, $V_{CC} = 15$ V (see Note 1), $R_T = 10$ k Ω , $C_T = 3.3$ nF, and $T_A = T_J$ (unless otherwise stated)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNITS
PWM Section							
Maximum duty avala			UC2842A, UC2843A	94	96	100	0/
Maximum duty cycle			UC2844A, UC2845A	47	48	50	%
Minimum duty cycle						0	%
Total Standby Current							
Start-up current					0.3	0.5	mA
Operating supply current	FB = 0 V,	SENSE = 0 V			11	17	mA
V _{CC} internal zener voltage	I _{CC} = 25 mA			30	34		V

- NOTES: 1. Adjust V_{CC} above the start threshold before setting at 15 V.
 - 2. Not production tested.
 - 3. Temperature stability, sometimes referred to as average temperature coefficient, is described by the equation: $V_{REF}\,(\text{max}) - V_{REF}\,(\text{min}).\,V_{REF}\,(\text{max})\,\text{and}\,V_{REF}\,(\text{min})\,\text{are}\,\text{the}\,\text{maximum}\,\text{and}\,\text{minimum}\,\text{reference}\,\text{voltage}\,\text{measured}$ Т_J (max) – Т_J (min)
 - over the appropriate temperature range. Note that the extremes in voltage do not necessarily occur at the extremes in temperature. 4. Output frequency equals oscillator frequency for the UC2842A and UC2843A. Output frequency is one half oscillator frequency for the
 - UC2844A and UC2845A. 5. This parameter is measured with $R_T = 10 \text{ k}\Omega$ to V_{RFF} . This contributes approximately 300 μ A of current to the measurement. The total
 - current flowing into the R_{T/C} pin will be approximately 300 μA higher than the measured value. 6. Parameter measured at trip point of latch with VFB at 0 V.
 - 7. Gain is defined by: $A = \frac{\Delta V_{COMP}}{A}$; $0 \le V_{SENSE} \le 0.8 \text{ V}$.

•PA

RAMETER MEASUREMENT INFORMATION



Error Amp can source and sink up to 0.5 mA, and sink up to 2 mA.

Figure 1. Error Amp Configuration



PARAMETER MEASUREMENT INFORMATION

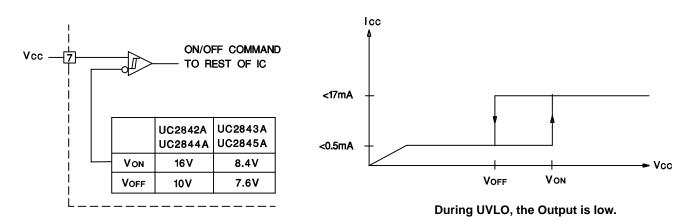
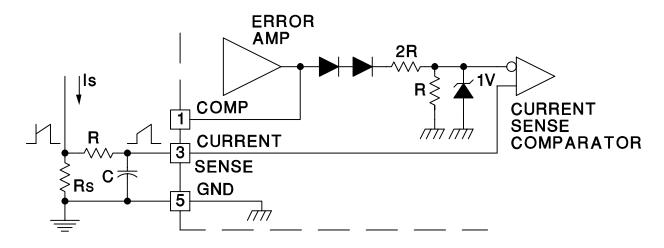


Figure 2. Under Voltage Lockout



Peak Current (Is) is Determined By The Formula:

$$Ismax'\frac{1.0V}{RS}$$

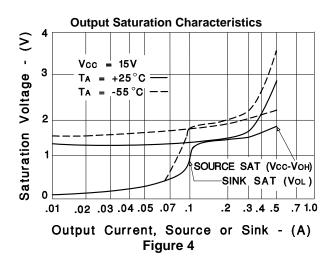
A small RC filter may be required to supress switch transients.

Figure 3. Current Sense Circuit



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PARAMETER MEASUREMENT INFORMATION



Error Amplifier Open-Loop Frequency Response 80 0 -45 80 -45 90 -135 -180 Frequency - (Hz)

Figure 5

PLICATION INFORMATION

Oscillator Frequency vs Timing Resistance

RT/CT 4 100k GROUND 5 100k For RT > 5k f ~ 1.72/RTCT 300 1.00k 3.00k 10.0k 30.0k 100k RT (ohms)

Maximum Duty Cycle vs Timing Resistor

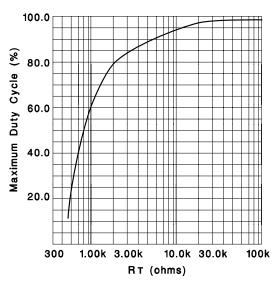
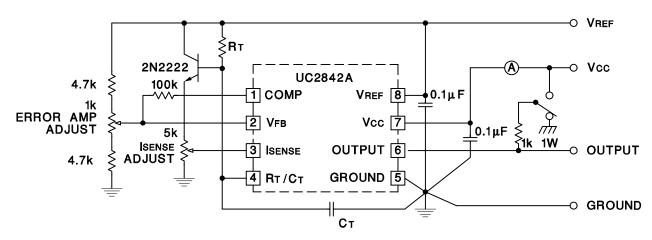


Figure 6. Oscillator

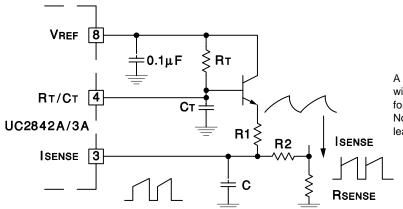
ΑP

APPLICATION INFORMATION



High peak currents associated with capacitive loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to pin 5 in a single point ground. The transistor and 5k potentiometer are used to sample the oscillator waveform and apply an adjustable ramp to pin 3.

Figure 7. Open-Loop Laboratory Text Fixture



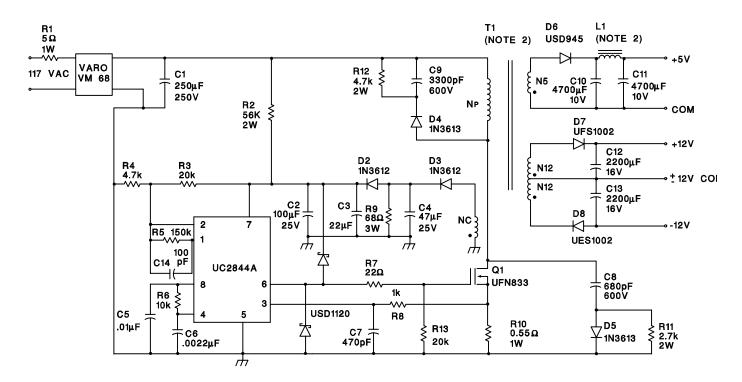
A fraction of the oscillator ramp can be resistively summed with the current sense signal to provide slope compensation for converters requiring duty cycles over 50%.

Note that capacitor, C, forms a filter with R2 to suppress the leading edge switch spikes.

Figure 8. Slope Complression

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APPLICATION INFORMATION



Power Supply Specifications

1. Input Voltage 95VAC to 130VAC (50Hz/60Hz)

Line Isolation 3750V
 Switching Frequency 40 kHz
 Efficiency, Full Load 70%

5. Output Voltage:

A. +5V, ±5%; 1A to 4A Load

B. +12V, $\pm 3\%$; 0.1A to 0.3A Load Ripple voltage: 100 mV P-P Max C. -12V, $\pm 3\%$; 0.1A to 0.3A Load Ripple voltage: 100 mV P-P Max

Figure 9. Off-Line Flyback Regulator







27-Feb-2006

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UC2842AQD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2842AQD8	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2842AQD8R	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2842AQDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2843AQD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2843AQD8	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2843AQD8R	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2843AQDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2845AQD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2845AQD8	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2845AQD8R	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
UC2845AQDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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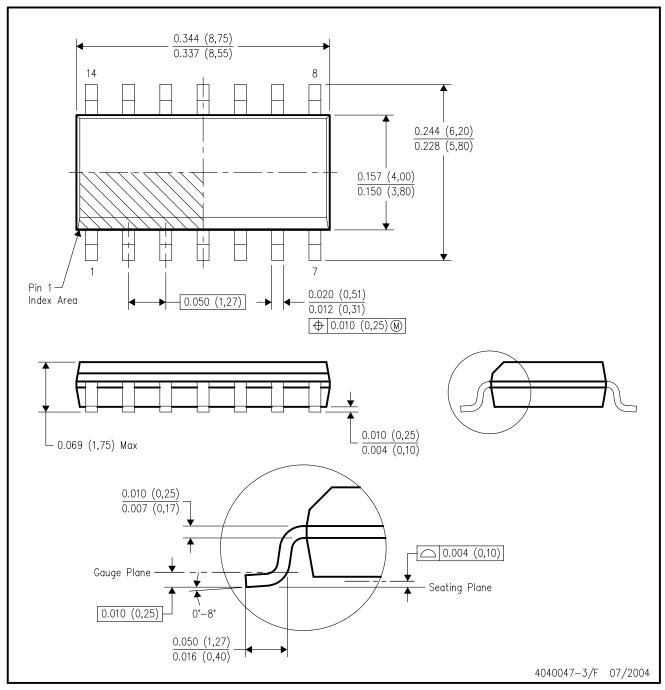
PACKAGE OPTION ADDENDUM

27-Feb-2006

no event shall TI's liability aris Customer on an annual basis	sing out of such information ex	ceed the total purchase p	price of the TI part(s) at issu	ue in this document sold by

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



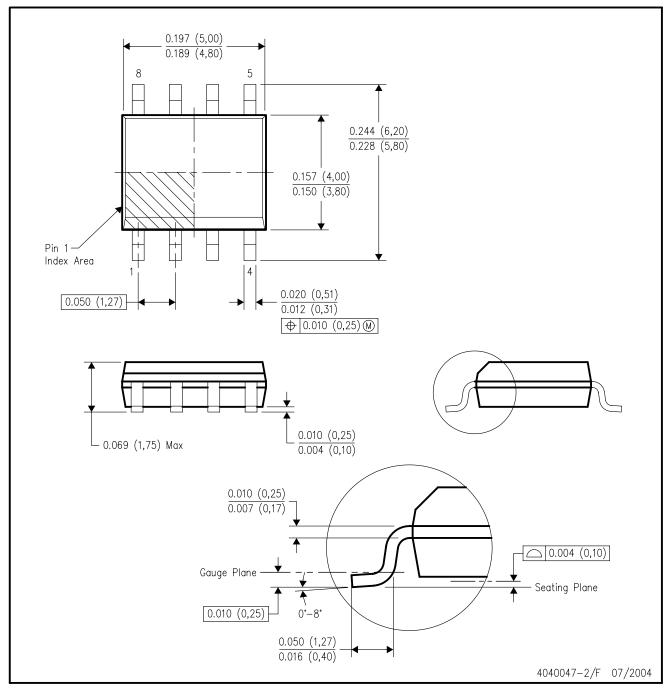
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



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